



**P-Channel Enhancement-Mode Vertical DMOS Power FETs**

**Ordering Information**

BV <sub>DSS</sub> / BV <sub>DGS</sub>	R <sub>DS(ON)</sub> (max)	I <sub>D(ON)</sub> (min)	Order Number / Package	
			TO-39	TO-92
-160V	100Ω	-100mA	VP1316N2	VP1316N3
-200V	100Ω	-100mA	VP1320N2	VP1320N3

**Features**

- Freedom from secondary breakdown
- Low power drive requirement
- Ease of paralleling
- Low C<sub>iss</sub> and fast switching speeds
- Excellent thermal stability
- Integral Source-Drain diode
- High input impedance and high gain
- Complementary N- and P-Channel devices

**Advanced DMOS Technology**

These enhancement-mode (normally-off) power transistors utilize a vertical DMOS structure and Supertex's well-proven silicon-gate manufacturing process. This combination produces devices with the power handling capabilities of bipolar transistors and with the high input impedance and negative temperature coefficient inherent in MOS devices. Characteristic of all MOS structures, these devices are free from thermal runaway and thermally-induced secondary breakdown.

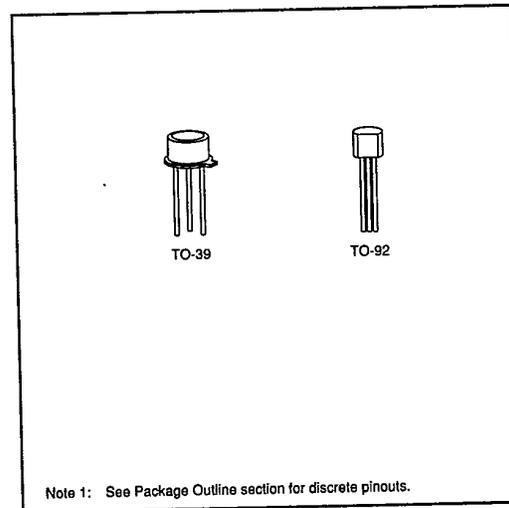
Supertex Vertical DMOS Power FETs are ideally suited to a wide range of switching and amplifying applications where high breakdown voltage, high input impedance, low input capacitance, and fast switching speeds are desired.

**Applications**

- Motor control
- Convertors
- Amplifiers
- Switches
- Power supply circuits
- Driver (Relays, Hammers, Solenoids, Lamps, Memories, Displays, Bipolar Transistors, etc.)

**Package Options**

(Note 1)



Note 1: See Package Outline section for discrete pinouts.

**Absolute Maximum Ratings**

Drain-to-Source Voltage	BV <sub>DSS</sub>
Drain-to-Gate Voltage	BV <sub>DGS</sub>
Gate-to-Source Voltage	± 20V
Operating and Storage Temperature	-55°C to +150°C
Soldering Temperature*	300°C

\*Distance of 1.6 mm from case for 10 seconds.

**Thermal Characteristics**

7-37-25 VP13C

Package	$I_D$ (continuous)*	$I_D$ (pulsed)*	Power Dissipation @ $T_C = 25^\circ\text{C}$	$\theta_{JA}$ °C/W	$\theta_{JC}$ °C/W	$I_{DR}$	$I_{DRM}^*$
TO-39	-0.10A	-0.40A	3.0W	125	41	-0.1A	-0.4A
TO-92	-0.06A	-0.30A	0.8W	170	155	-0.06A	-0.3A

\*  $I_D$  (continuous) is limited by max rated  $T_J$ .

**Electrical Characteristics (@ 25°C unless otherwise specified)**

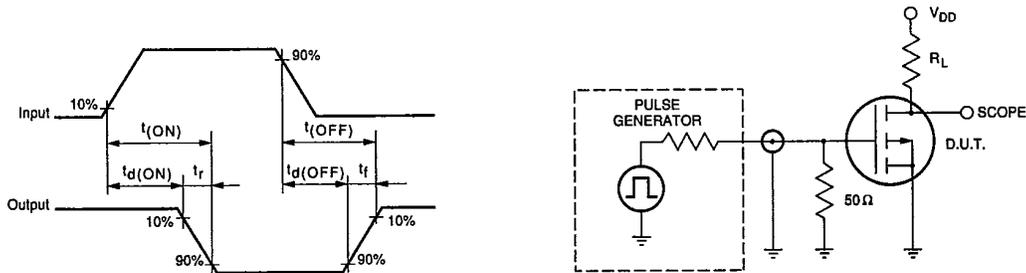
(Notes 1 and 2)

Symbol	Parameter	Min	Typ	Max	Unit	Conditions
$BV_{DSS}$	Drain-to-Source Breakdown Voltage	VP1320	-200		V	$I_D = -1\text{mA}, V_{GS} = 0$
		VP1316	-160			
$V_{GS(th)}$	Gate Threshold Voltage	-1.5		-3.5	V	$V_{GS} = V_{DS}, I_D = -1\text{mA}$
$\Delta V_{GS(th)}$	Change in $V_{GS(th)}$ with Temperature		-4.0	-5.0	mV/°C	$V_{GS} = V_{DS}, I_D = -1\text{mA}$
$I_{GSS}$	Gate Body Leakage		0.1	100	nA	$V_{GS} = \pm 20\text{V}, V_{DS} = 0$
$I_{DSS}$	Zero Gate Voltage Drain Current			-10	$\mu\text{A}$	$V_{GS} = 0, V_{DS} = \text{Max Rating}$
				-500		$V_{GS} = 0, V_{DS} = 0.8 \text{ Max Rating}$ $T_A = 125^\circ\text{C}$
$I_{D(ON)}$	ON-State Drain Current	-50	-100		mA	$V_{GS} = -5\text{V}, V_{DS} = -25\text{V}$
		-100	-400		mA	$V_{GS} = -10\text{V}, V_{DS} = -25\text{V}$
$R_{DS(ON)}$	Static Drain-to-Source ON-State Resistance		65	100	$\Omega$	$V_{GS} = -5\text{V}, I_D = -40\text{mA}$
			60	100	$\Omega$	$V_{GS} = -10\text{V}, I_D = -150\text{mA}$
$\Delta R_{DS(ON)}$	Change in $R_{DS(ON)}$ with Temperature		0.6	1.0	%/°C	$I_D = -50\text{mA}, V_{GS} = -10\text{V}$
$G_{FS}$	Forward Transconductance	20	30		mS	$V_{DS} = -25\text{V}, I_D = -150\text{A}$
$C_{ISS}$	Input Capacitance		35	40	pF	$V_{GS} = 0, V_{DS} = -25\text{V}$ $f = 1 \text{ MHz}$
$C_{OSS}$	Common Source Output Capacitance		10	15		
$C_{RSS}$	Reverse Transfer Capacitance		2	5		
$t_{d(ON)}$	Turn-ON Delay Time		1.5	5	ns	$V_{DD} = -25\text{V}$ $I_D = -200\text{mA}$ $R_S = 50\Omega$
$t_r$	Rise Time		2.5	5		
$t_{d(OFF)}$	Turn-OFF Delay Time		1.5	5		
$t_f$	Fall Time		2.5	5		
$V_{SD}$	Diode Forward Voltage Drop		1.6	2.0		
$t_{rr}$	Reverse Recovery Time		350		ns	$I_{SD} = -1\text{A}, V_{GS} = 0$

Note 1: All D.C. parameters 100% tested at 25°C unless otherwise stated. (Pulse test: 300µs pulse, 2% duty cycle.)

Note 2: All A.C. parameters sample tested.

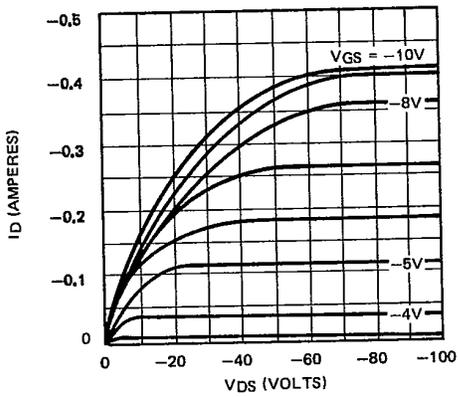
**Switching Waveforms and Test Circuit**



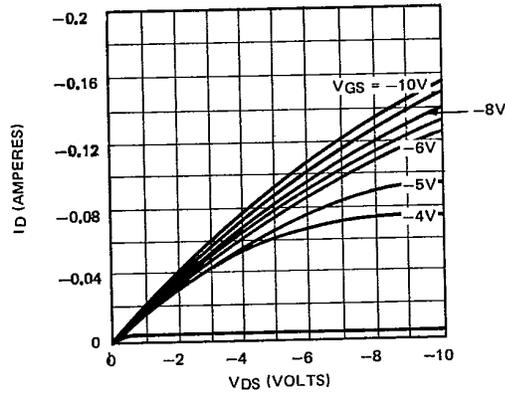
Typical Performance Curves

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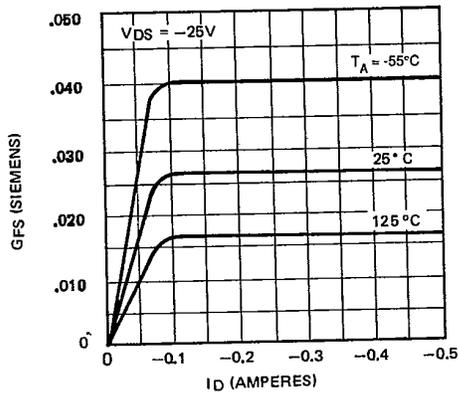
Output Characteristics



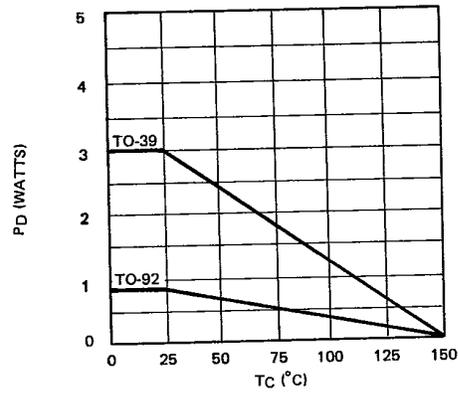
Saturation Characteristics



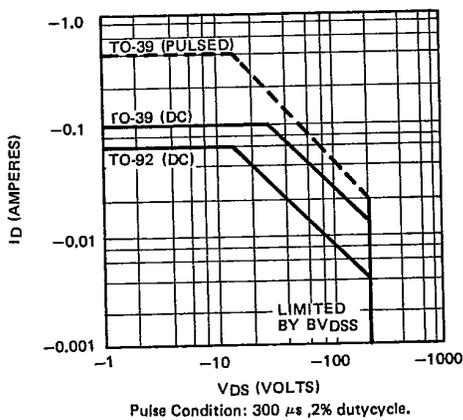
Transconductance Vs. Drain Current



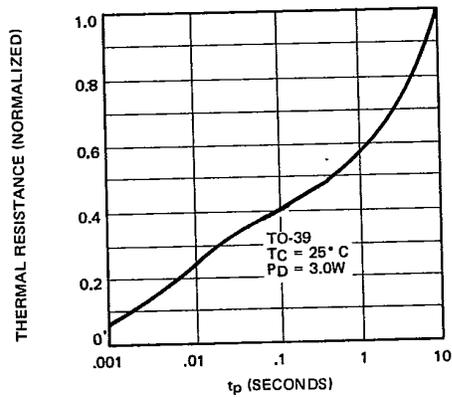
Power Dissipation Vs. Case Temperature



Maximum Rated Safe Operating Area



Thermal Response Characteristics



7-37-25

